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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
TECHNOLOGY CENTER 2800

In re Application of:

Sambasivam, et al.

Serial No.: 10/033,854 ✓

Filed: December 19, 2001

For: UNDERFILL MATERIALS
DISPENSED IN A FLIP CHIP
PACKAGE BY WAY OF A
THROUGH HOLE

Examiner: Scott Brairton

Group Art Unit: 2823

Attorney Docket No.: 42390.P13267

CERTIFICATE OF MAILING

I hereby certify that this paper or fee along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.

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RESPONSE

Hon. Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Official Action mailed June 5, 2002, please consider the following
remarks: